



SUA-210HSx-xx-S236

外殼材質：

Blank:BRASS

I:SPCC

Housing Color :

Black : B

White : W

鍍層厚度：

Blank : 1u"

2 : 15u"

3 : 30u"

PCB LAYOUT

SPECIFICATIONS

Electrical:

- 1.Contact Resistance: 30 mΩ Max
- 2.Insulation Resistance: 1,000 MΩ Min
- 3.Dielectric Withstanding Voltage: 500V AC

Material:

- 1.Housing: PBT
- 2.Contact: Brass
- 3.Shell: Brass / Spcc

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS
OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
DATE: 05/11/22

CHECKED BY: Jacky Chen
DATE: 05/11/22

APPROVED BY: Tony Kao
DATE: 05/11/22

MATL	TITLE	CONNECTOR
FINISH	MODLE	USB A/F 雙層半包外殼平彈
SCALE	DWG NO.	SUA-210HSx-xx-S236
SHEET NO.	PART NO.	SUA-210HSx-xx-S236

SIZE
A4
VER
R3